



SEMITRANS®2

Fast IGBT4 Modules

SKM100GB12T4

Features

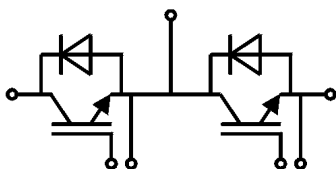
- IGBT4 = 4. Generation (Trench)IGBT
- VCEsat with positive temperature coefficient
- High short circuit capability, self limiting to $6 \times I_{C\text{NOM}}$
- Soft switching 4. Generation CAL diode (CAL4)

Typical Applications

- AC inverter drives
- UPS
- Electronic welders at fsw up to 20 kHz

Remarks

- Case temperature limited to $T_c = 125^\circ\text{C}$ max, recomm.
Top = $-40 \dots +150^\circ\text{C}$, product rel. results valid for $T_j = 150^\circ$



GB

Absolute Maximum Ratings

Symbol	Conditions		Values	Unit
IGBT				
V _{CES}			1200	V
I _C	T _j = 175 °C	T _c = 25 °C	160	A
		T _c = 80 °C	123	A
I _{Cnom}			100	A
I _{CRM}	I _{CRM} = 3xI _{Cnom}		300	A
V _{GES}			-20 ... 20	V
t _{psc}	V _{CC} = 800 V V _{GE} ≤ 15 V V _{CES} ≤ 1200 V	T _j = 150 °C	10	μs
T _j			-40 ... 175	°C
Inverse diode				
I _F	T _j = 175 °C	T _c = 25 °C	121	A
		T _c = 80 °C	91	A
I _{Fnom}			100	A
I _{FRM}	I _{FRM} = 3xI _{Fnom}		300	A
I _{FSM}	t _p = 10 ms, sin 180°, T _j = 25 °C		550	A
T _j			-40 ... 175	°C
Module				
I _{t(RMS)}			200	A
T _{stg}			-40 ... 125	°C
V _{isol}	AC sinus 50Hz, t = 1 min		4000	V

Characteristics

Symbol	Conditions		min.	typ.	max.	Unit
IGBT						
V _{CE(sat)}	I _C = 100 A	T _j = 25 °C		1.8	2.05	V
	V _{GE} = 15 V chipelevel	T _j = 150 °C		2.2	2.4	V
V _{CE0}		T _j = 25 °C		0.8	0.9	V
		T _j = 150 °C		0.7	0.8	V
r _{CE}	V _{GE} = 15 V	T _j = 25 °C		10.0	11.5	mΩ
		T _j = 150 °C		15.0	16.0	mΩ
V _{GE(th)}	V _{GE} =V _{CE} , I _C = 3.8 mA		5	5.8	6.5	V
I _{CES}	V _{GE} = 0 V	T _j = 25 °C		0.1	0.3	mA
	V _{CE} = 1200 V	T _j = 150 °C				mA
C _{ies}	V _{CE} = 25 V	f = 1 MHz		6.15		nF
C _{oes}	V _{GE} = 0 V	f = 1 MHz		0.40		nF
C _{res}		f = 1 MHz		0.345		nF
Q _G	V _{GE} = - 8 V...+ 15 V			565		nC
R _{Gint}	T _j = 25 °C			7.5		Ω
t _{d(on)}	V _{CC} = 600 V	T _j = 150 °C		165		ns
t _r	I _C = 100 A	T _j = 150 °C		47		ns
E _{on}	V _{GE} = ±15 V	T _j = 150 °C		15		mJ
t _{d(off)}	R _{G on} = 1 Ω	T _j = 150 °C		400		ns
t _f	R _{G off} = 1 Ω	T _j = 150 °C		75		ns
E _{off}	di/dt _{on} = 1800 A/μs	T _j = 150 °C		10.2		mJ
R _{th(j-c)}	per IGBT				0.27	K/W



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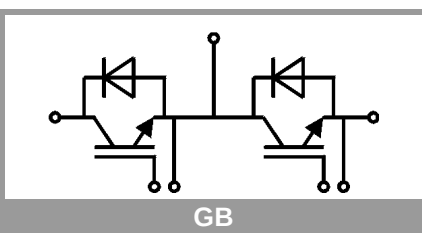
Typical Applications

- AC inverter drives
- UPS
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Remarks

- Case temperature limited to $T_c = 125^\circ\text{C}$ max, recomm.
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Characteristics						
Symbol	Conditions		min.	typ.	max.	Unit
Inverse diode						
$V_F = V_{EC}$	$I_F = 100\text{ A}$	$T_j = 25\text{ }^{\circ}\text{C}$		2.2	2.52	V
	$V_{GE} = 0\text{ V}$ chip	$T_j = 150\text{ }^{\circ}\text{C}$		2.15	2.47	V
V_{F0}		$T_j = 25\text{ }^{\circ}\text{C}$		1.3	1.5	V
		$T_j = 150\text{ }^{\circ}\text{C}$		0.9	1.1	V
r_F		$T_j = 25\text{ }^{\circ}\text{C}$		9.0	10.2	mΩ
		$T_j = 150\text{ }^{\circ}\text{C}$		12.5	13.7	mΩ
I_{RRM}	$I_F = 100\text{ A}$	$T_j = 150\text{ }^{\circ}\text{C}$		54		A
Q_{rr}	$di/dt_{off} = 1600\text{ A}/\mu\text{s}$	$T_j = 150\text{ }^{\circ}\text{C}$		15.7		μC
E_{rr}	$V_{GE} = \pm 15\text{ V}$ $V_{CC} = 600\text{ V}$	$T_j = 150\text{ }^{\circ}\text{C}$		5.9		mJ
$R_{th(j-c)}$	per diode				0.48	K/W
Module						
L_{CE}					30	nH
$R_{CC'+EE'}$	terminal-chip	$T_C = 25\text{ }^{\circ}\text{C}$		0.65		mΩ
		$T_C = 125\text{ }^{\circ}\text{C}$		1		mΩ
$R_{th(c-s)}$	per module			0.04	0.05	K/W
M_s	to heat sink M6		3		5	Nm
M_t		to terminals M5	2.5		5	Nm
						Nm
w					160	g



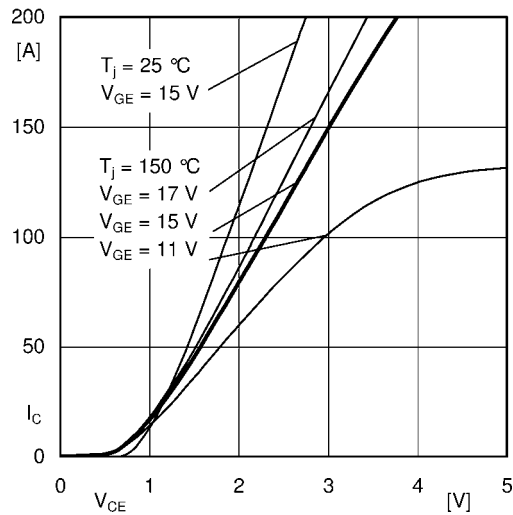


Fig. 1: Typ. output characteristic, inclusive $R_{CC'} + E_{E'}$

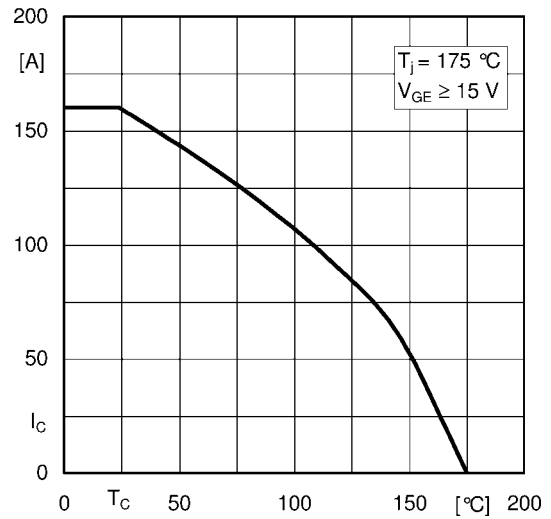


Fig. 2: Rated current vs. temperature $I_C = f(T_C)$

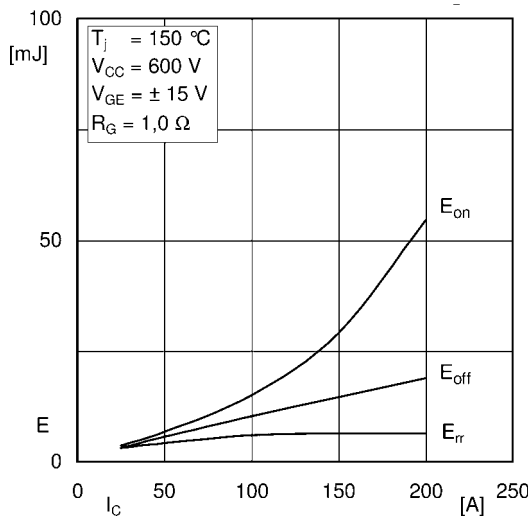


Fig. 3: Typ. turn-on /-off energy = $f(I_C)$

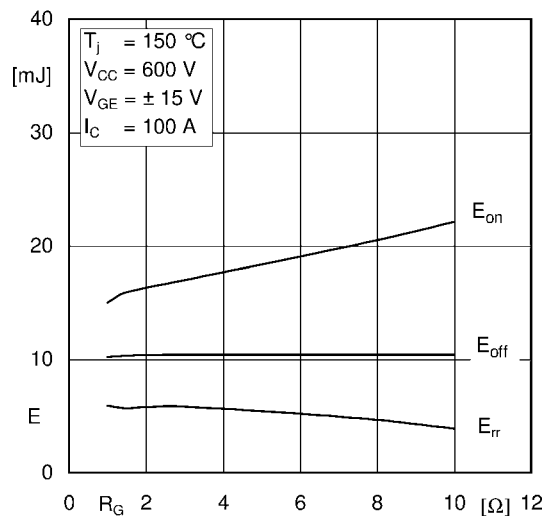


Fig. 4: Typ. turn-on /-off energy = $f(R_G)$

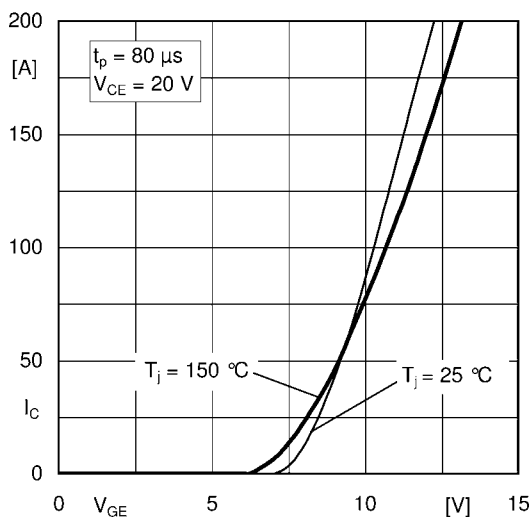


Fig. 5: Typ. transfer characteristic

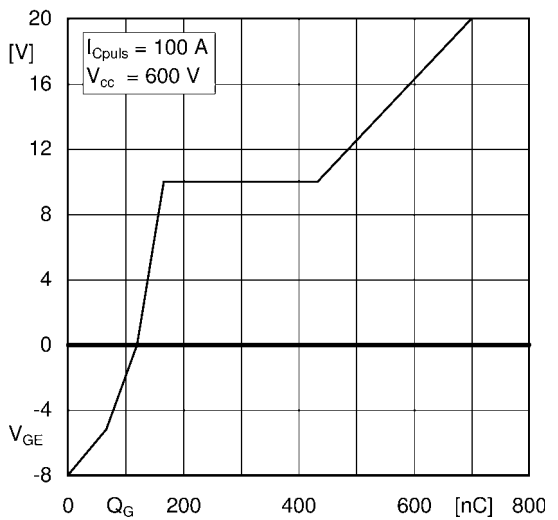
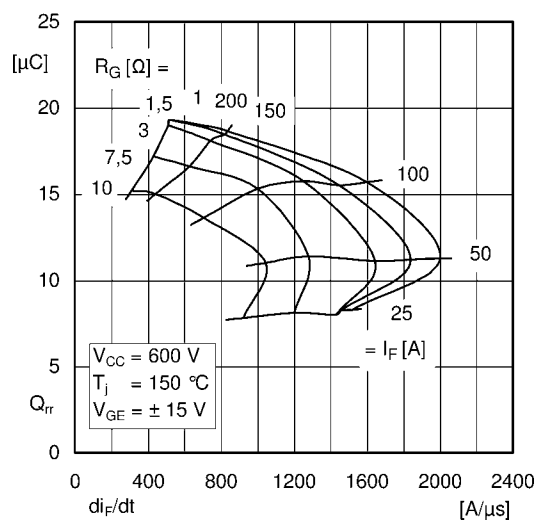
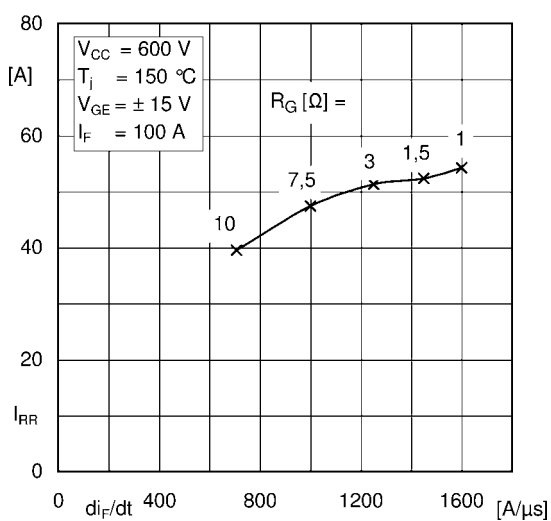
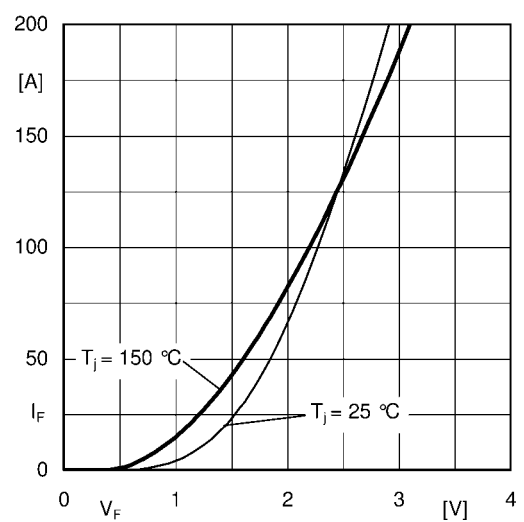
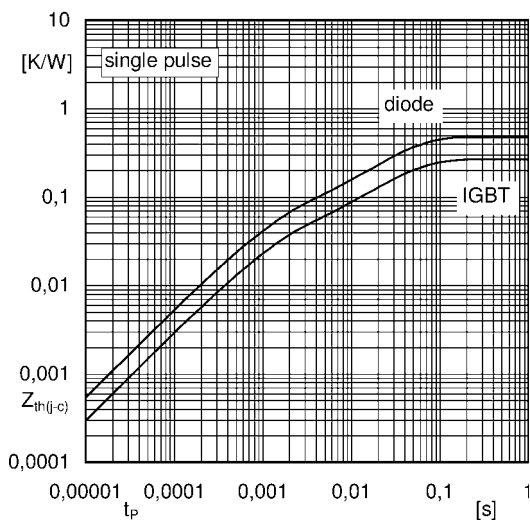
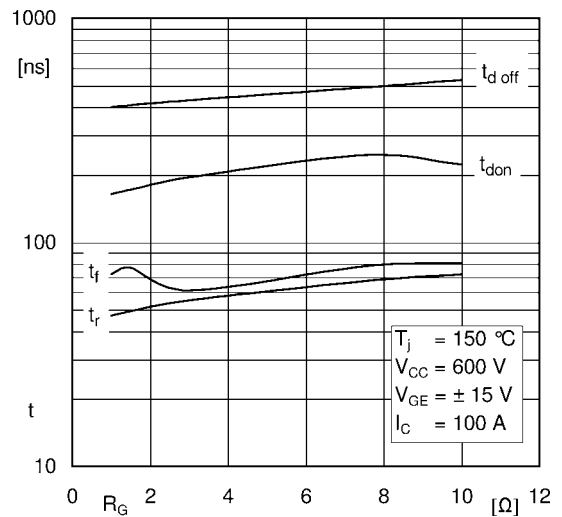
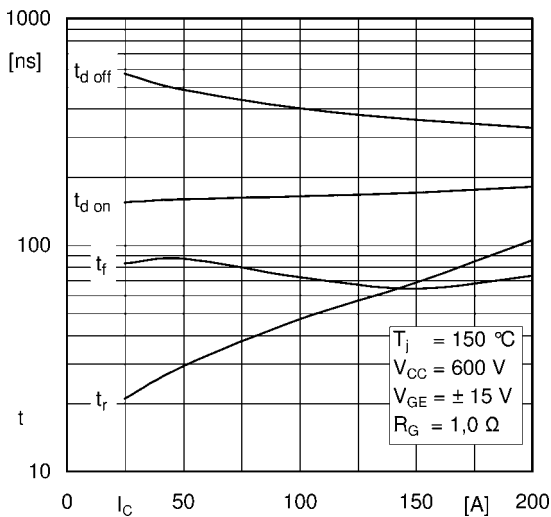
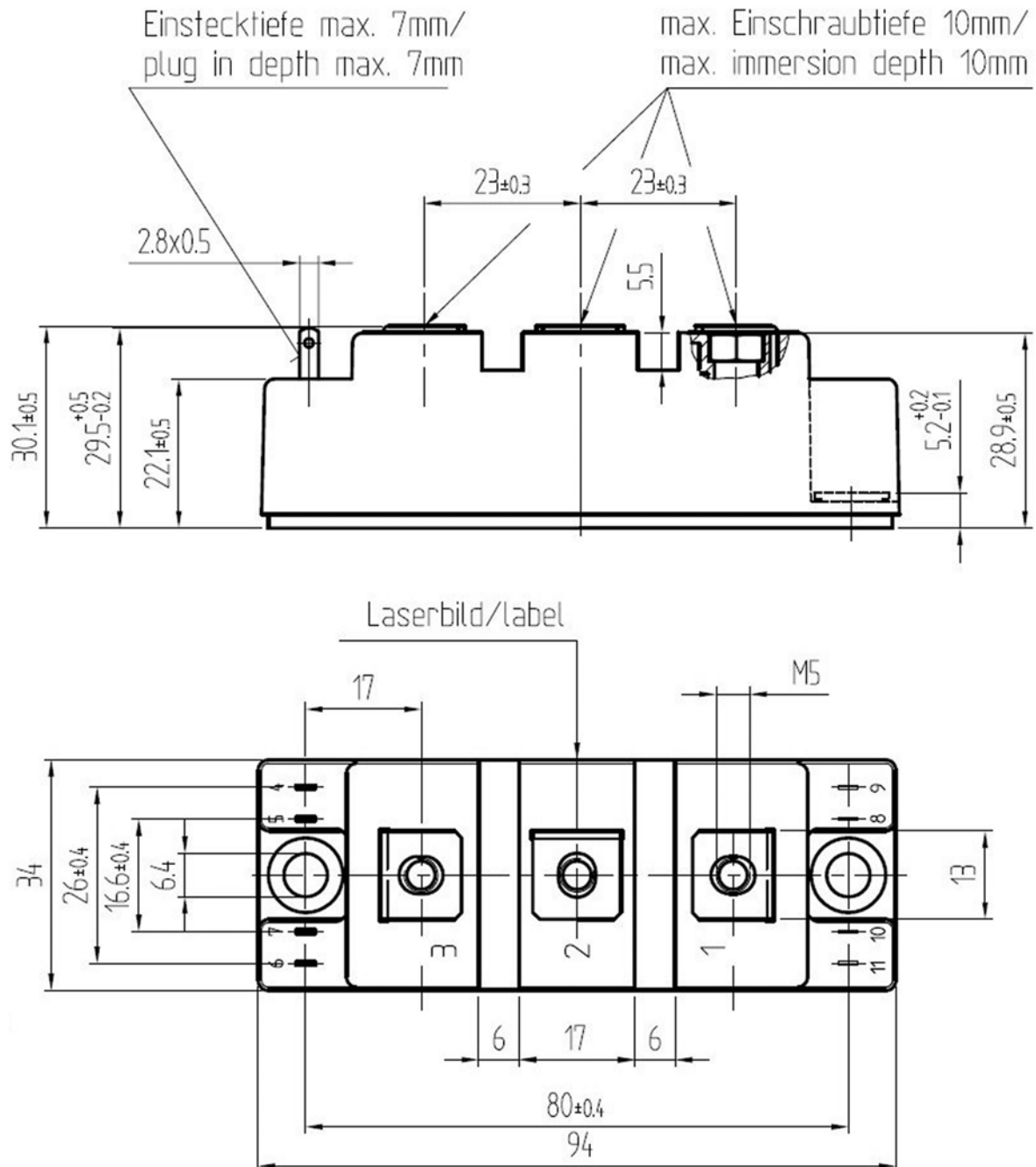
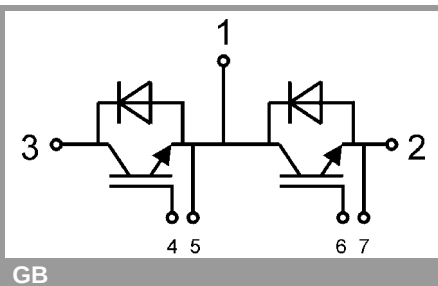


Fig. 6: Typ. gate charge characteristic





Semitrans 2



This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

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